

GaAs INTEGRATED CIRCUIT $\mu PG158TB$

L, S- BAND SPDT SWITCH

DESCRIPTION

The μ PG158TB is a L-band SPDT (Single Pole Double Throw) GaAs FET switch which was developed for digital cellular, cordless telephone and other L, S-band wireless application. The device can operate from 500 MHz to 2.5 GHz, having the low insertion loss. It housed in an original 6-pin super minimold package that is smaller than usual 6-pin minimold easy to install and contributes to miniaturizing the system.

FEATURES

- Low Insertion Loss: LINS = 0.3 dB TYP. @VCONT = +3.0 V/0 V, f = 1 GHz
 - LINS = 0.4 dB TYP. @VCONT = +3.0 V/0 V, f = 2 GHz
 - LINS = 0.5 dB TYP. @VCONT = +3.0 V/0 V, f = 2.5 GHz
- High isolation: ISL = 27 dB TYP. $@V_{CONT} = +3.0 V/0 V$, f = 0.5 to 2 GHz
 - Small 6-pin super minimold package (Size: $2.0 \times 1.25 \times 0.9$ mm)

APPLICATIONS

- L, S-band digital cellular or cordless telephone
- PCS, WLAN, WLL and Bluetooth applications

ORDERING INFORMATION

| Part Number | Marking | Package | Supplying Form |
|-------------|---------|----------------------|--|
| μPG158TB-E3 | G1M | 6-pin super minimold | Embossed tape 8 mm wide. Pin 1, 2, 3 face to tape perforation side. Qty 3 kp/reel. |

- **Remark** To order evaluation samples, please contact your local NEC sales office. (Part number for sample order: μPG158TB)
- Caution The IC must be handled with care to prevent static discharge because its circuit is composed of GaAs MES FET.

The information in this document is subject to change without notice. Before using this document, please confirm that this is the latest version. Not all devices/types available in every country. Please check with local NEC representative for availability and additional information.

ABSOLUTE MAXIMUM RATINGS (TA = +25 °C)

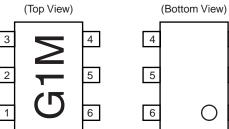
| Parameter | Symbol | Ratings | Unit |
|-------------------------|-----------|------------------------------|------|
| Control Voltage 1, 2 | VCONT1, 2 | -6.0 to +6.0 ^{Note} | V |
| Input Power | Pin | +28 | dBm |
| Total Power Dissipation | Ptot | 0.15 | W |
| Operating Temperature | TA | -45 to +85 | °C |
| Storage Temperature | Tstg | -45 to +150 | °C |

Note Condition $2.5 \le |V_{CONT1} - V_{CONT2}| \le 6.0 V$

- **Remarks 1.** Mounted on a $50 \times 50 \times 1.6$ mm double copper clad epoxy glass PWB, T_A = +85 °C
 - 2. Operation in excess of any one of these parameters may result in permanent damage.

PIN CONNECTIONS

| Pin No. | Connection | Pin No. | Connection |
|---------|------------|---------|------------|
| 1 | OUT1 | 4 | Vcont2 |
| 2 | GND | 5 | IN |
| 3 | OUT2 | 6 | Vcont1 |



| (Bottom View) | | | | | |
|---------------|---|--|--|--|--|
| | | | | | |
| | 3 | | | | |
|] | | | | | |
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| | | | | | |

RECOMMENDED OPERATING CONDITIONS (T_A = +25 °C)

| Parameter | Symbol | MIN. | TYP. | MAX. | Unit |
|------------------------|--------|------|------|------|------|
| Control Voltage (High) | VCONT | +2.5 | +3.0 | +5.3 | V |
| Control Voltage (Low) | VCONT | -0.2 | 0 | +0.2 | V |

ELECTRICAL CHARACTERISTICS

(Unless otherwise specified, $T_A = +25$ °C, $V_{CONT1} = 3$ V, $V_{CONT2} = 0$ V or $V_{CONT1} = 0$ V, $V_{CONT2} = 3$ V, Off chip DC blocking capacitors value; 51 pF)

| Parameter | Symbol | Test Conditions | MIN. | TYP. | MAX. | Unit |
|---|-------------|--|------|----------------------|------|------|
| Insertion Loss | Lins | f = 0.5 to 1.0 GHz | - | 0.3 | 0.55 | dB |
| | | f = 2.0 GHz | - | 0.4 | 0.65 | |
| | | f = 2.5 GHz | - | 0.5 ^{Note1} | _ | |
| Isolation | ISL | f = 0.5 to 2.0 GHz | 22 | 27 | - | dB |
| | | f = 2.5 GHz | - | 23 ^{Note1} | - | |
| Input Return Loss | RLin | f = 0.5 to 2.0 GHz | 13 | 19 | - | dB |
| Output Return Loss | RLout | f = 0.5 to 2.0 GHz | 13 | 19 | - | dB |
| Input Power at 0.1 dB Compression Point ^{Note2} | Pin(0.1 dB) | f = 1.0 GHz, V _{CONT} = 3 V/0 V | _ | 23.0 | _ | dBm |
| Input Power at 1 dB Compression Point ^{Note2} | Pin(1 dB) | f = 1.0 GHz, V _{CONT} = 3 V/0 V | 22.0 | 26.5 | _ | dBm |
| Switching Speed | tsw | | - | 50 | 200 | ns |
| Control Current | ICONT | $V_{CONT} = 3 V/0 V$ | - | 0.5 | 10 | μA |

Notes 1. Characteristic for reference at 2.0 to 2.5 GHz

- 2. Pin(0.1 dB) or Pin(1 dB) is measured the input power level when the insertion loss increases more 0.1 dB or 1 dB than that of linear range. All other characteristics are measured in linear range.
- Cautions 1. When the μ PG158TB is used it is necessary to use DC blocking capacitors for No. 1 (OUT1), No.3 (OUT2) and No.5 (IN). The value of DC blocking capacitors should be chosen to accommodate the frequency of operation, band width, switching speed and the condition with actual board of your system.

The range of recommended DC blocking capacitor value is less than 100 pF.

2. The distance between IC's GND pin and ground pattern of substrate should be as shorter as possible to avoid parasitic parameters.

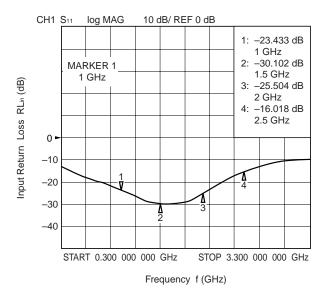
TYPICAL CHARACTERISTICS

TEST CONDITIONS: VCONT = 3 V/0 V, Pin = 0 dBm, TA = +25 °C

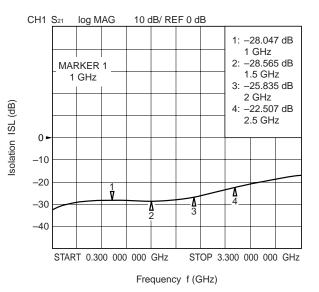


N ○ OUT1 ○ OUT2 \$ 50 Ω

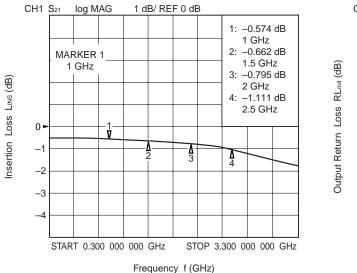
IN-OUT1 INPUT RETURN LOSS vs. FREQUENCY



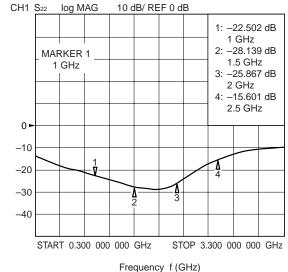
IN-OUT1 ISOLATION vs. FREQUENCY



IN-OUT1 INSERTION LOSS vs. FREQUENCY



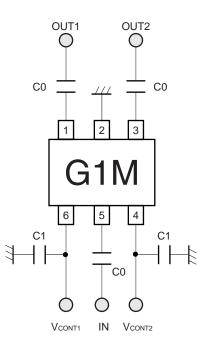
IN-OUT1 OUTPUT RETURN LOSS vs. FREQUENCY



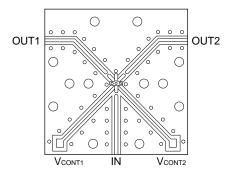
Caution This data is including loss of the test fixture.

TEST CIRCUIT

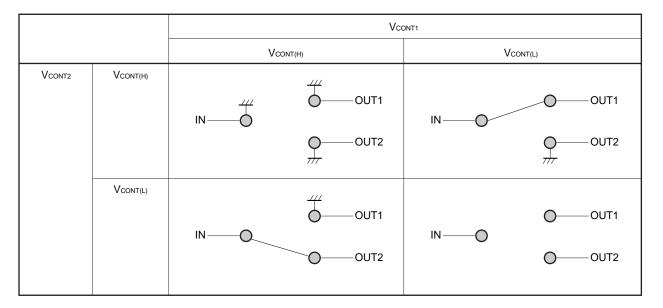
TA= +25 °C, VCONT1 = +3 V, VCONT2 = 0 V or VCONT1 = 0 V, VCONT2 = +3 V, f = 2 GHz Off chip DC blocking capacitors value: C0 = 51 pF, C1 = 1000 pF (Bypass), Using NEC standard evaluation board



★ EVALUATION BOARD



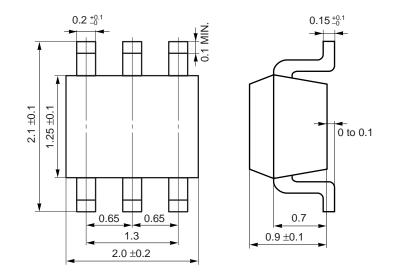
TRUTH TABLE OF SWITCHING BY CONDITION OF CONTROL VOLTAGE



PACKAGE DIMENSIONS

NEC

6 PIN SUPER MINIMOLD (UNIT: mm)



RECOMMENDED SOLDERING CONDITIONS

This product should be soldered under the following recommended conditions. For soldering method and conditions other than those recommended below, contact your NEC sales representative.

| Soldering Method | Soldering Conditions | Recommended Condition Symbol |
|------------------|---|---------------------------------|
| Infrared Reflow | Package peak temperature: 235 °C or below Time: 30 seconds or less (at 210 °C) Count: 3, Exposure limit: None ^{Note} | IR35-00-3 |
| VPS | Package peak temperature: 215 °C or below Time: 40 seconds or less (at 200 °C) Count: 3, Exposure limit: None ^{Note} | VP15-00-3 |
| Wave Soldering | Soldering bath temperature: 260 °C or below Time: 10 seconds or less Count: 1, Exposure limit: None ^{Note} | WS60-00-1 |
| Partial Heating | Pin temperature: 300 °C Time: 3 seconds or less (per pin row) Exposure limit: None ^{№ee} | - |

Note After opening the dry pack, keep it in a place below 25 °C and 65 % RH for the allowable storage period.

Caution Do not use different soldering methods together (except for partial heating).

For details of recommended soldering conditions for surface mounting, refer to information document **SEMICONDUCTOR DEVICE MOUNTING TECHNOLOGY MANUAL (C10535E).**

CAUTION

The Great Care must be taken in dealing with the devices in this guide. The reason is that the material of the devices is GaAs (Gallium Arsenide), which is designated as harmful substance according to the law concerned. Keep the law concerned and so on, especially in case of removal.

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